

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE75H11 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

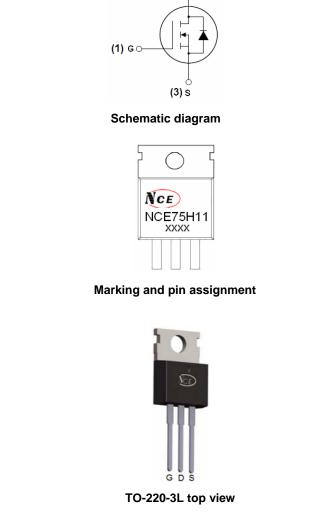
- $V_{DS} = 75V, I_D = 110A$ $R_{DS(ON)} < 9m\Omega @ V_{GS} = 10V$ (Typ:7.5m Ω)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



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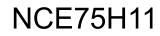
Package Marking and Ordering Information

	<u> </u>	V			
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE75H11	NCE75H11	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	75	V
Gate-Source Voltage	Vgs	±25	V
Drain Current-Continuous	Ι _D	110	А
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	78	A
Pulsed Drain Current	I _{DM}	350	A
Maximum Power Dissipation	PD	210	W





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Derating factor		1.4	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	1200	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R _{θJc}	0.71	°C/W

Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			·			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	75	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =75V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			·			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	7.5	9.0	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =40A	60	-	-	S
Dynamic Characteristics (Note4)			·			
Input Capacitance	C _{lss}		-	4700	-	PF
Output Capacitance	C _{oss}	V _{DS} =30V,V _{GS} =0V, F=1.0MHz	-	440	-	PF
Reverse Transfer Capacitance	C _{rss}		-	260	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	21	-	nS
Turn-on Rise Time	tr	V_{DD} =30V, RL=1 Ω	-	39	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =2.5 Ω	-	70	-	nS
Turn-Off Fall Time	t _f		-	24	-	nS
Total Gate Charge	Qg	V -20V(L -20A	-	114	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =30V,I _D =30A, V _{GS} =10V	-	33	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	18	-	nC
Drain-Source Diode Characteristics			·			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	110	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 40A	-	43	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3) - 93		93	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t ≤ 10 sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

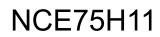
4. Guaranteed by design, not subject to production

5. EAS condition: Tj=25 $^\circ C$,VDD=37.5V,VG=10V,L=0.5mH,Rg=25 Ω



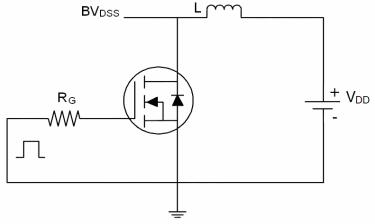
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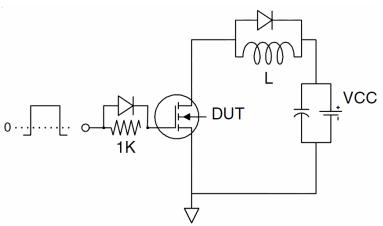


Test circuit

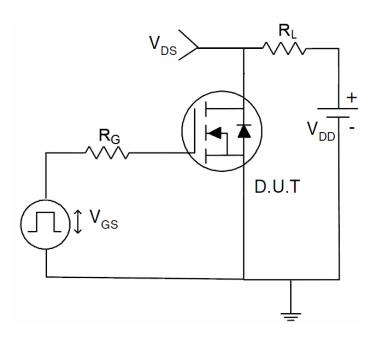
1) E_{AS} test Circuit



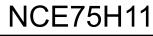
2) Gate charge test Circuit



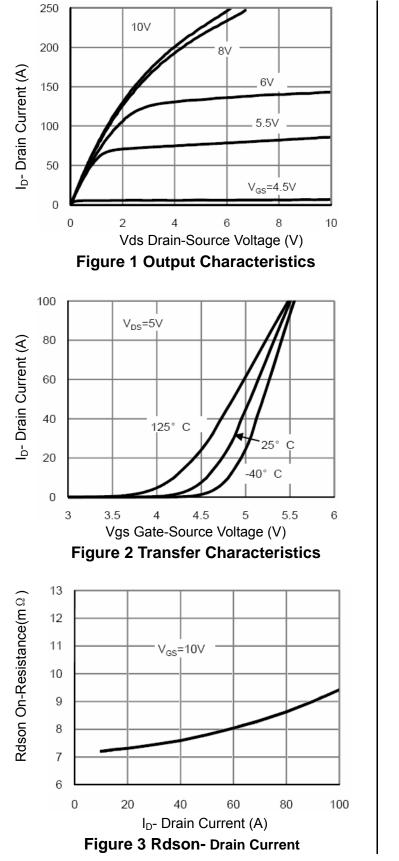
3) Switch Time Test Circuit

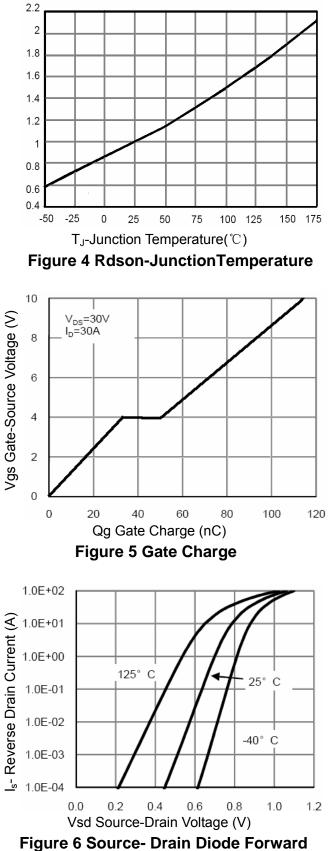






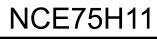
Typical Electrical and Thermal Characteristics (Curves)

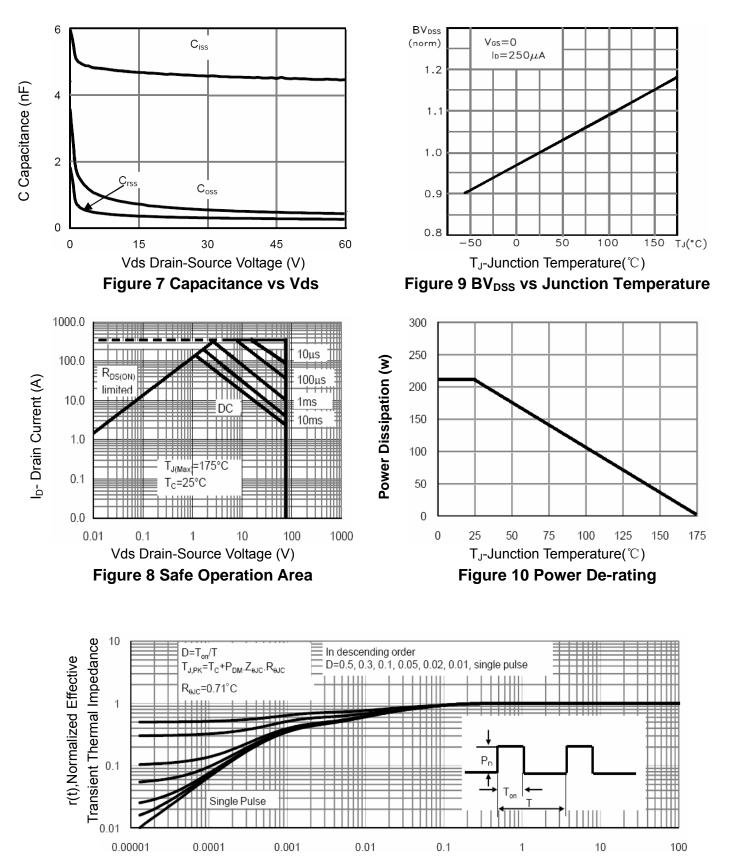










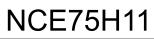


Square Wave Pluse Duration(sec)

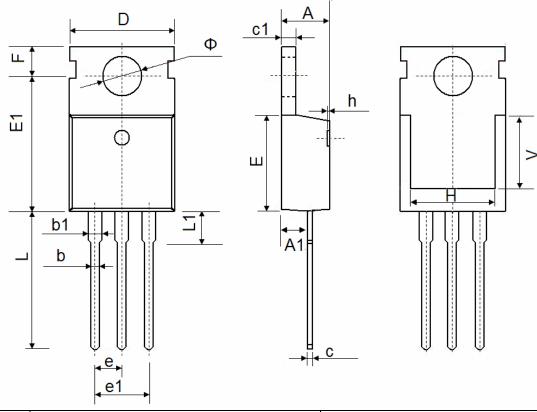




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TO-220-3L Package Information



Symbol	Dimensions	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295 REF.		
Ф	3.400	3.800	0.134	0.150	







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